

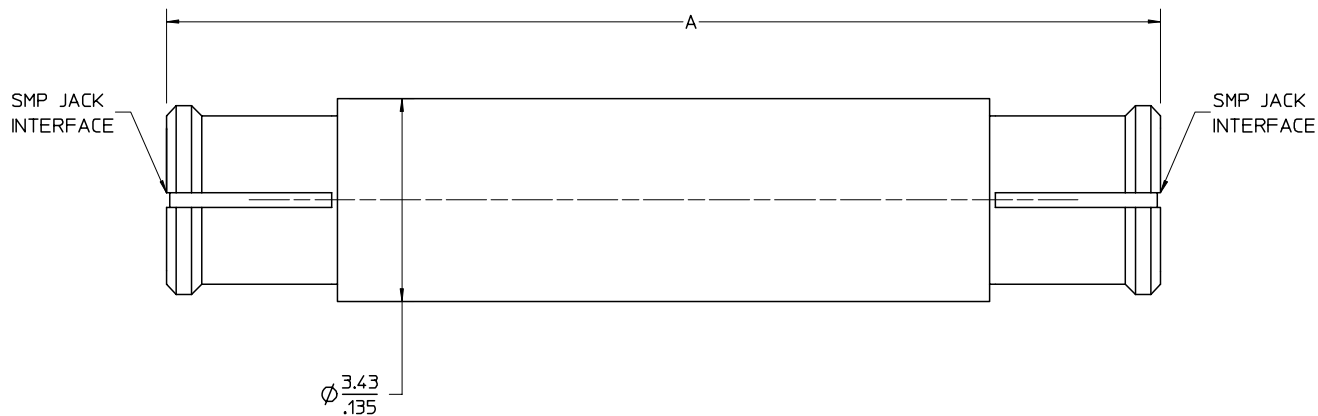
10 9 8 7 6 5 4 3 2 1

MATERIALS AND FINISHES

BODY: BERYLLIUM COPPER
 PLATED: GOLD 30 MICROINCH MIN

CENTER CONTACT: BERYLLIUM COPPER
 PLATED: GOLD 30 MICROINCH MIN

INSULATOR: TEFLON



73415-4790	.760 REF	19.31 REF
PART #	DIM A	

PS-89675-3320	PRODUCT SPECIFICATION
MIL-STD-348A, FIG 326.1	INTERFACE
SPECIFICATION	DESCRIPTION

DIM 19.31 WAS 17.08 EC NO: URF2005-0542 DRWN:CLLI 2005/06/20 CHKD: 2005/06/20 APPR:MUANG 2005/06/20	QUALITY SYMBOLS
	$\nabla = 0$ $\nabla C = 0$
	DESCRIPTION
	REV

GENERAL TOLERANCES (UNLESS SPECIFIED)	mm	INCH
	4 PLACES \pm ---	\pm ---
	3 PLACES \pm ---	\pm ---
	2 PLACES ± 0.13	\pm ---
1 PLACE ± 0.25	\pm ---	
ANGULAR $\pm 2^\circ$		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		

DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
MM/IN		---	METRIC	\odot \square
DRAWN BY	DATE	TITLE	SMP JACK ADAPTER SMP-J/J/ADP	
DARRY	2004/03/16			
CHECKED BY	DATE			
KERRIE	2004/03/16		MOLEX INCORPORATED	
APPROVED BY	DATE			
MISEN	2004/03/16		MOLEX INCORPORATED	
MATERIAL NO.	DOCUMENT NO.	SHEET NO.		
	SEE TABLE	SD-73415-479	1 OF 1	

9 8 7 6 5 4 3 2 1